

04-29-2003

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To the Honorable Commissioner of I

Marks: Please record the attached original documents or copy thereof.

## 1. Name of conveying party(ies):

Chien-Ping HUANG  
Yu-Po WANG  
Chih-Ming HUANG

4. 22. 03

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

## 3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other

Execution Date: December 30, 2002

## 2. Name and address of receiving party(ies):

Name: Siliconware Precision Industries Co., Ltd.

Address: No. 123, Sec. 3, Da Fong Road, Tantz,

Taichung, Taiwan, R.O.C.

City: State/Prov.:

Country: ZIP:

Additional name(s) &amp; address(es)

☐ Yes ☐ No

## 4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is: April 22, 2003

Patent Application No.

Filing date

B. Patent No.(s)

04/24/2003 RHARIS1 00000008 10420427  
02 FC:8021 40.00 OP

Additional numbers

☐ Yes ☒ No

## 5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Peter F. Corless

Registration No. 33,860

Address: EDWARDS &amp; ANGELL, LLP

P.O. Box 9169

City: Boston State/Prov.: MA

Country: USA ZIP: 02209

## 6. Total number of applications and patents involved:

1

## 7. Total fee (37 CFR 3.41):.....\$ 40.00

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## 9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Peter F. Corless

Name of Person Signing

Signature

April 22, 2003

Date

Total number of pages including cover sheet, attachments, and

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Mail documents to be recorded with required cover sheet information to:  
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# ASSIGNMENT OF U.S. PATENT APPLICATION

In consideration of the sum of One Dollar in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned

Inventor(s) (1) Chien Ping HUANG (2) Yu- Po WANG  
 Full Name(s) (3) Chin-Ming HUANG

Hereby sell, assign and transfer to

Assignee Siliconware Precision Industries Co., LTD  
 Name and Address No. 123, Sec.3, Da Fong Road,  
Tantzu, Taichung, Taiwan R.O.C

(hereinafter called the Assignee) the entire right, title, and interest in and to any and all improvements which are disclosed in the Application for United States Letters Patent entitled

SEMICONDUCTOR PACKAGE FREE OF SUBSTRATE AND FABRICATION  
Method THEREOF

Which application was

Complete either a) executed by the undersigned on \_\_\_\_\_  
 b) filed on the \_\_\_\_\_  
 Serial No. \_\_\_\_\_

Including any and all United States Letters Patents which may be granted therefore and any and all extensions, divisions, reissues, substitutes, renewals or continuations thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property.

It is hereby authorized and requested that the Commissioner of Patents issue any and all of said Letters Patent, when granted, to said assignee.

Further, it is agreed that, when requested, without charge to but at the expense of said Assignee, the undersigned will execute all divisional, continuing, substitute, renewal, and reissue patent applications; execute all rightful other papers; and generally do everything possible which said Assignee shall consider desirable for aiding in securing and maintaining proper patent protection.

Date \_\_\_\_\_ Signed at Taichung, Taiwan R.O.C  
 On 12/30/02

Inventor(s) Chien-Ping Huang Chien Ping HUANG  
 Full Signature(s) Yu-Po Wang Yu- Po WANG  
Chin-Ming Huang Chin-Ming HUANG